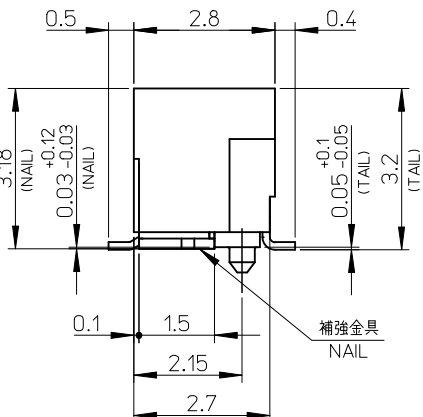
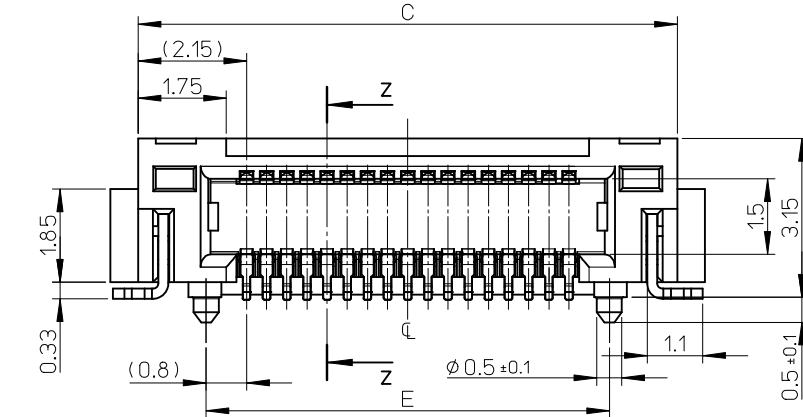
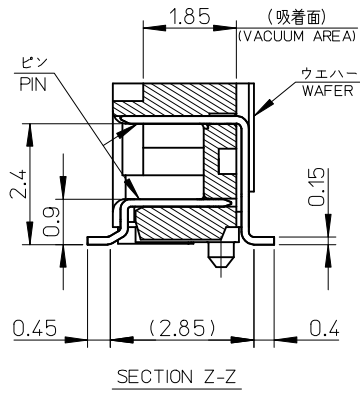
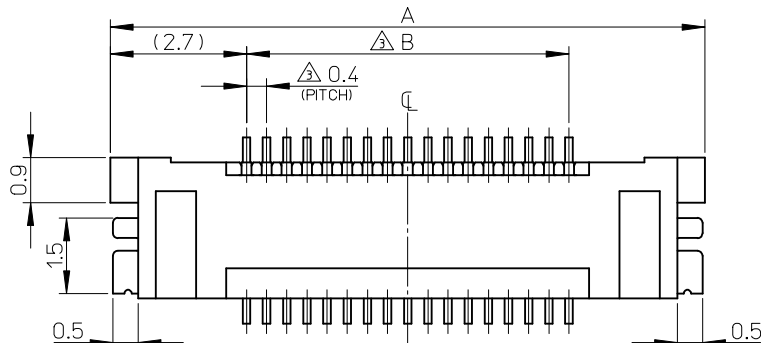




注記 NOTES

1. 使用材料 MATERIAL
ウエハー: 液晶ポリマー ガラス充填 UL94V-0 黒色
WAFER: LIQUID CRYSTAL POLYMER, GLASS FILLED, UL94V-0, COLOR BLACK
ピン: リン青銅
PIN: PHOSPHOR BRONZE
補強金具: リン青銅
FITTING NAIL: PHOSPHOR BRONZE
2. メッキ仕様 PLATING
ピン PIN
コンタクト部: 部分金めっき (0.25 μm 以上)
テール部: 部分金めっき
下地: ニッケルめっき (1.5 μm 以上)
CONTACT AREA: SEPARATED GOLD PLATING (0.25 MICROMETER MINIMUM)
SOLDER TAIL AREA: SEPARATED GOLD PLATING
UNDERPLATE: NICKEL OVERALL (1.5 MICROMETER MINIMUM)
補強金具 FITTING NAIL
錫めっき (1.0 μm 以上)
下地: ニッケルめっき (1.0 μm 以上)
TIN PLATING (1.0 MICROMETER MINIMUM)
UNDERPLATE: NICKEL OVERALL (1.0 MICROMETER MINIMUM)
- △ テール部に適用。
APPLY TO THE TAIL AREA.
4. 嵌合相手: 54552 シリーズ
MATE WITH: 54552 SERIES.
5. テール平坦度は、0.08 以下
テール及び金具の平坦度は、0.1 以下
TAIL COPLANARITY TO BE 0.08 MAXIMUM
TAIL AND FITTING NAIL COPLANARITY TO BE 0.1 MAXIMUM
6. ELV 及び RoHS 適合品
ELV AND RoHS COMPLIANT

9.2	10.5	11.9	7.6	13.0	503376-4010	40
8.0	9.3	10.7	6.4	11.8	503376-3410	34
7.2	8.5	9.9	5.6	11.0	503376-3010	30
E	D	C	B	A	EMBOSSED PACKAGE オーダー番号 ORDER No.	極数 CIRCUITS

CONNECTOR SERIES No. : 503376-**19

SCALE 10:1 DESIGN UNITS METRIC THIRD ANGLE PROJECTION

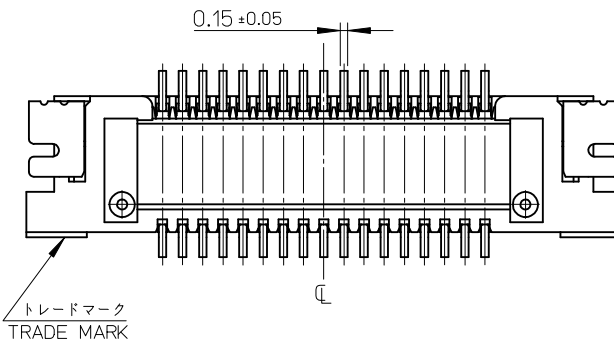
TITLE 0.4 B-TO-B CONN. RA PLUG NAIL ASSY (WITH BOSS)

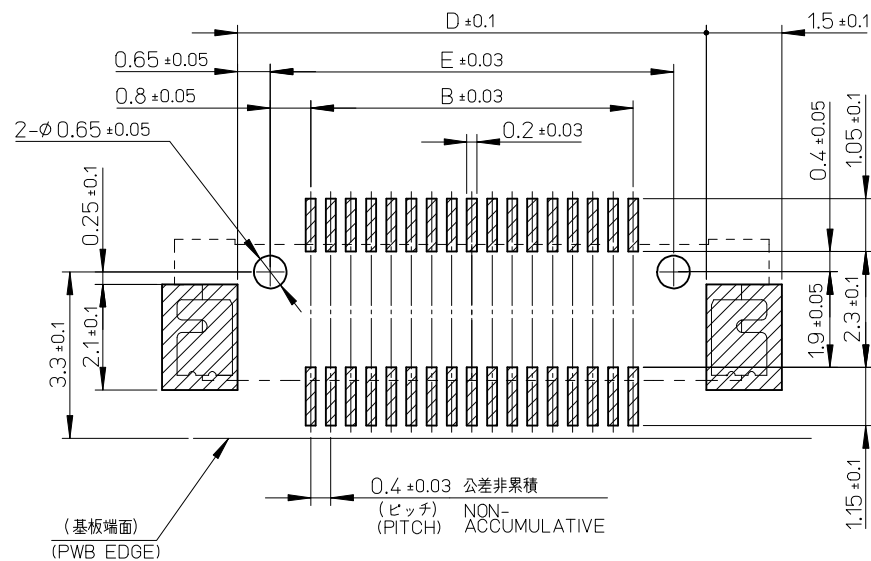
MOLEX MOLEX INCORPORATED

DOCUMENT NO. SD-503376-001 SHEET NO. 1 OF 2

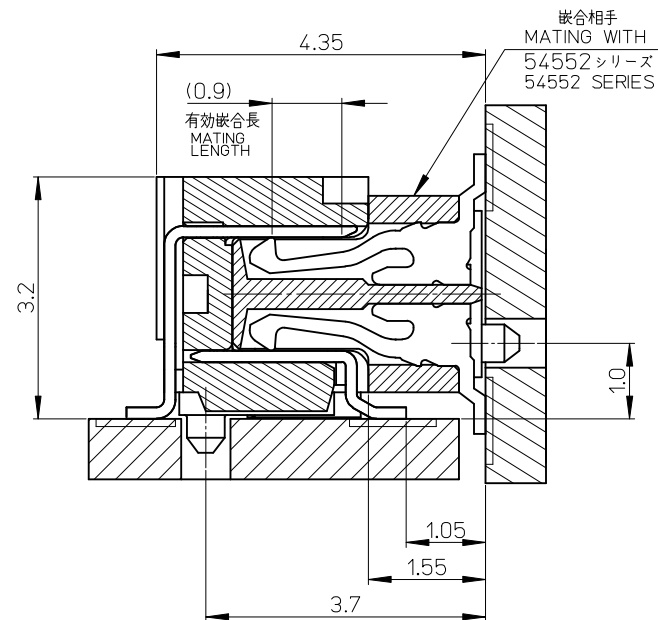
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

REVISED EC NO: J2010-0351 DRWN: TOSHIMA CHKD: SMARUYAMA APPR: MSASAO A	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)	
		10 UNDER	± 0.2
		10 OVER 30 UNDER	± 0.25
		30 OVER	± 0.3
		ANGULAR ±3 °	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	





推奨基板レイアウト(マウント面)
RECOMMENDED P.W.BOARD
PATTERN DIMENSION. (REFERENCE)
(MOUNTING AREA)



嵌合断面 及び ボス位置 (参考)
MATED AND BOSS POSITION
DRAWING(REFERENCE)

REVISED EC NO.: J2010-0351 DRWN: TOSHIMA CHKD: SMARUYAMA APPR: MSASAO	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		CONNECTOR SERIES No. : 503376-**19
		10 UNDER	± 0.2	DRAWN BY M. TAKASAKI	DATE 2009/06/03	SCALE 15:1
		10 OVER 30 UNDER	± 0.25	CHECKED BY M. HAYASHI	DATE 2009/06/03	DESIGN UNITS METRIC
		30 OVER	± 0.3	APPROVED BY N. UKITA	DATE 2009/06/03	THIRD ANGLE PROJECTION
A	REV	ANGULAR ± 3 °		MATERIAL NO. SEE CHART		TITLE 0.4 B-T0-B CONN. RA PLUG NAIL ASSY (WITH BOSS)
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		DOCUMENT NO. SD-503376-001		SHEET NO. 2 OF 2
				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

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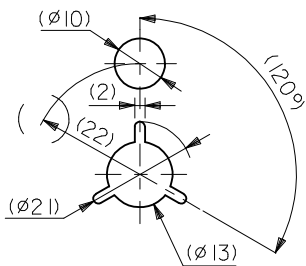
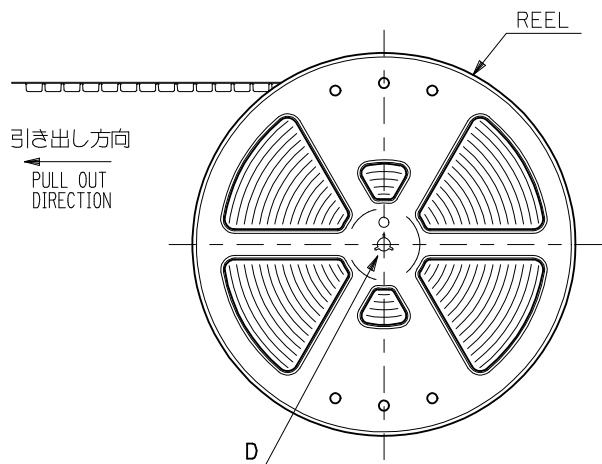
5

4

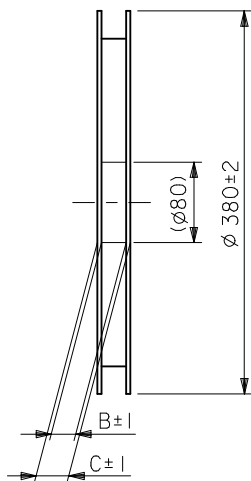
3

2

1

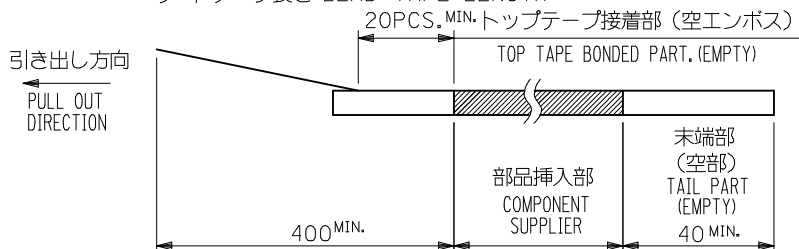


DETAIL D



NOTES

- 製品詳細寸法については SD-503376-001 を参照ください。
RE DETAILED DIMENSION, SEE SD-503376-001
- 梱包数量：1500個/リール
NUMBER OF CONNECTORS : 1500PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH



- 材料 (MATERIAL)
キャリアテープ (CARRIER TAPE) : ポリプロピレン (POLYPROPYLENE)
トップテープ (TOPTAPE) : PET, PE, PEF
リール (REEL) : ポリスチレン (PS) (リサイクル材を含む)
POLYSTYRENE (PS) <RECYCLE MATERIAL CONTAINED>
- ELV 及び RoHS適合品
ELV AND RoHS COMPLIANT.

503376-4010	40
503376-3410	34
503376-3010	30
MATERIAL NO.	極数 CIRCUITS

REVISED EC NO.: J2010-0351 DRWN: TOSHIMA CHKD: SMARUYAMA APPR: MSASAO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	M. TAKASAKI	2009/06/03	TITLE EMBSTP PKG FOR 0.4 B/B CONN. RA PLUG NAIL ASSY				
		10 OVER 30 UNDER	± 0.25	M. HAYASHI	2009/06/03					
		30 OVER	± 0.3	N. UKITA	2009/06/03	MOLEX MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.				SHEET NO.
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-503376-002				1 OF 2	
A	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

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10 9 8 7 6 5 4 3 2 1

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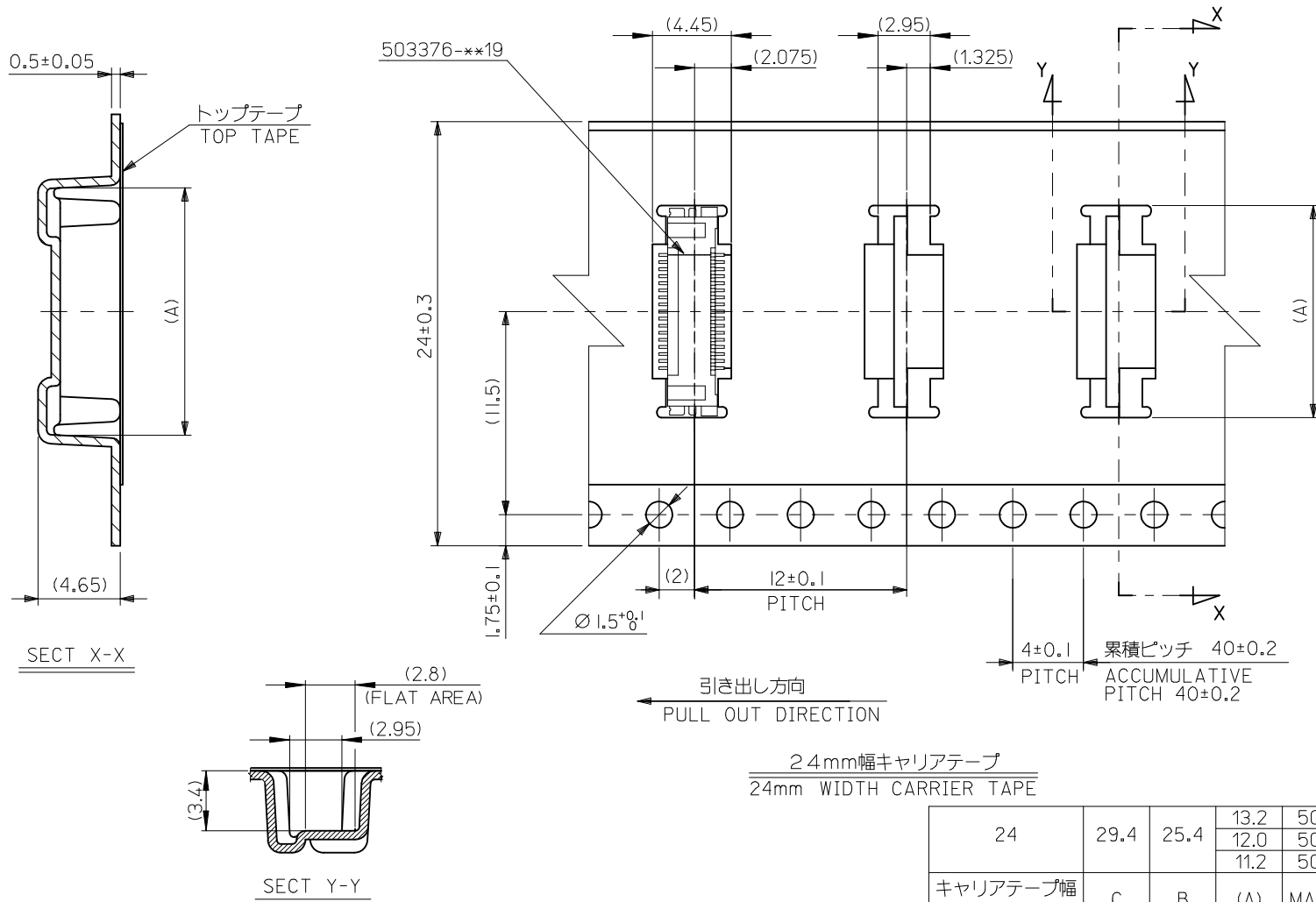
E

D

C

B

A



24	29.4	25.4	13.2	503376-4010	40
			12.0	503376-3410	34
			11.2	503376-3010	30
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	(A)	MATERIAL NO.	極数 CIRCUITS

REVISED EC NO: J2010-0351 DRWN: TOSHIMA CHKD: SMARUYAMA APPR: MSASAO A	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	MODEL NO.	THIRD ANGLE		
				MM ONLY		---	DESIGN UNITS	PROJECTION		
		10 UNDER		±0.2	DRAWN BY	DATE	TITLE EMBSTP PKG FOR 0.4 B/B CONN. RA PLUG NAIL ASSY			
		10 OVER 30 UNDER		±0.25	CHECKED BY	DATE				
		30 OVER		±0.3	APPROVED BY	DATE				
	ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.			
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-503376-002		2 OF 2			
REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						